



ED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Cecile BERNE et al.

Confirmation No. 2144

Application No.: 10/733,431

Group Art Unit: 2812

Filing Date: December 10, 2003

Examiner:

For: TWO STAGE ANNEALING METHOD FOR

Atty. Docket No.: 4717-5499

MANUFACTURING SEMICONDUCTOR

STRUCTURES

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Pursuant to applicants' duty of disclosure under 37 C.F.R. 1.56, applicants submit herewith (5) references for the Examiner's review and consideration. These references were cited in the European Search Report and a copy is enclosed.

These references are listed on the enclosed Form PTO-1449. It is respectfully requested that these references be made of record in this application by the Examiner's completion and return of the PTO Form 1449.

No fee is believed to be due for the filing of this statement as it is being submitted prior to an initial office action for this application. Should any fees be required, however, please charge such fees to Winston & Strawn **LLP** Deposit Account No. 50-1814.

Date:

Respectfully submitted,

Allan A. Fanucci

(Reg. No. 30,256)

WINSTON & STRAWN LLP CUSTOMER NO. 28765

(212) 294-3311

Enclosures

NY:859033.1

LIST OF REFERENCES CITED BY APPLICANT

(Use several sheets if necessary)

APPLICATION SERIAL NO.: ATTY. DOCKET NO.: 4717-5499 10/733,431

APPLICANT:

Cecile BERNE et al.

FILING DATE:

GROUP:

			December), 2003	2812		
			U.S.	PATENT DOCU	JMENTS				
*EXAMINER INITIAL		DOCUMENT NUMBER DATE		NAME		CLASS	SUBCLASS	FILING D APPROPI	
	AA	5,877,070	3/1999	Goesele et al.		438	458		
	AB	6,303,468 10/2001		Aspar et al.		438	455		
	AC								
	AD								
	AE.								
	AF								
		·	FORE	IGN PATENT DO	CUMENTS			,	
		DOCUMENT NUMBER	DATE		COUNTRY	CLASS	SUBCLASS	TRANSI YES	NO
	AG	FR 2767416 w/ English Abstract	2/1999	France				X	
	АН								
	ΑI								
	AJ								
		OTHER REFI	ERENCES (I	cluding Author,	Title, Date, Pertinen	t Pages, Etc.)			
	AK	B. Aspar et al: XP001050558 "The Generic Nature Of The Smart-Cut Process For Thin Film Transfer", Journal Of Electronic Materials, Vol. 30, No. 7, 22, pp. 834-840, (2001)							
	AL	B. Aspar et al: XP000884996, "Smart-Cut Technology: An Industrial Application Of Ion Implementation Induced Cavities", Materials Research Society Symposium Proceedings, Materials Research Society, Vol. 510, No. 13, pp 381-393 (19998)							
	AM								
		EXAMINER		DAT	E CONSIDERED				

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.